Tin Whiskers with Special Morphology Yaowu Shi and Hu Hao <u>haohu@emails.bjut.edu.cn</u> The Beijing University of Technology

Rapid tin whisker growth on the surface of <u>Sn-3.8Ag-0.7Cu-1.0Ce/Er/Y* solder joints</u> has been investigated. The results show that, besides the regular pencil-shaped whiskers, spiral tin whisker; plate-like whisker; bent whiskers with many continuous kinks; tin whisker with a non-constant cross section; branch-type tin whisker and joining-type tin whisker were also found in our study. These tin whiskers are shown as follows:

* Sn = Tin	Ag = Silver	Cu = Copper
Ce = Cerium	Er = Erbium	Y = Yttrium

1. Spiral tin whisker and distorted tin whisker

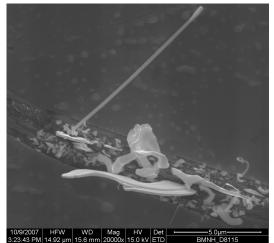


Storage at room temperature in air for 720hr, on the surface of $CeSn_3$ phase

2. Irregular plate-like tin whisker and regular ribbon-like tin whisker



Storage at room temperature in air for 820hr, on the surface of CeSn₃ phase

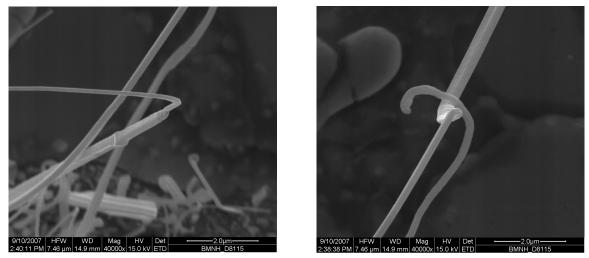


Storage at 125 °C in air for 20min, then at room temperature for 260hr, on the surface of $ErSn_3$ phase



Storage at 150 °C in air for 20min, on the surface of $ErSn_3$ phase

3. Tin whiskers with non-constant cross section



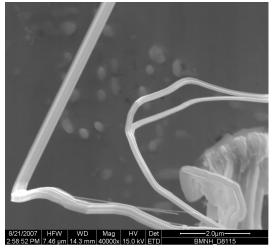
Storage at 150 °C in air for 20min, on the surface of ErSn₃ phase



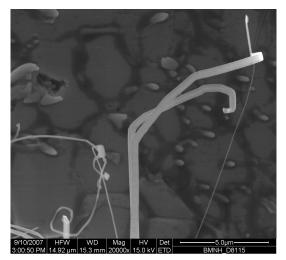
Storage at room temperature in air for 312hr, on the surface of ErSn₃ phase

Tin Whiskers with Special Morphology Yaowu Shi and Hu Hao <u>haohu@emails.bjut.edu.cn</u> The Beijing University of Technology

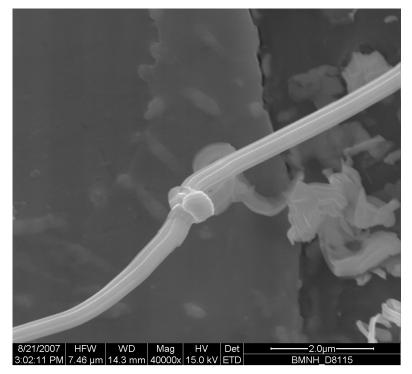
4. Branch-type tin whiskers



Storage at room temperature in air for 312hr, on the surface of $CeSn_3$ phase



Storage at 150 °C in air for 20min, on the surface of ErSn₃ phase



Storage at room temperature in air for 312hr, on the surface of CeSn₃ phase

5. Tin whisker with a joint